OSRAM GF CSSRML.24 Datasheet

Published by ams-OSRAM AG Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved



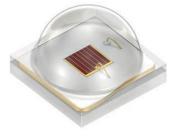


OSLON® Optimal

GF CSSRML.24

A brand new family of LEDs with our ams OSRAM's latest chip technology, delivering significant performance upgrades. Offered in four colors for ease of design and flexibility for all your horticulture spectrum needs. With Hyper Red (660 nm), Deep Blue (450 nm), Far Red (730 nm) and Horti White options to select from both narrow spectrum and full spectrum solutions can be designed to meet all crop needs for both greenhouses and vertical farms.

The OSLON® Optimal strikes a perfect balance of performance and cost along with proven robustness, high reliability and long lifetime.





Applications

- Architecture

- Horticulture Lighting

Features

- Package: SMT ceramic package with silicone lens
- Typ. Radiation: 120° (Lambertian emitter)
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)
- Radiant Flux: typ. 440 mW
- Radiant Efficiency: typ. 64.5%
- Photon Flux: typ. 2.69 umol/s
- Photon Flux Efficacy: typ. 3.94 umol/J



Ordering Information

Туре	Total radiant flux ¹⁾ Ι _F = 350 mA Φ	Ordering Code
GF CSSRML.24-TNUL-1-1	380 565 mW	Q65113A4445



Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T _{op}	min.	-40 °C
	οp	max.	125 °C
Storage Temperature	T _{stg}	min.	-40 °C
	otg	max.	125 °C
Junction Temperature	T _j	max.	135 °C
Forward current	I _F	min.	30 mA
	·	max.	1000 mA
Surge Current	I _{FS}	max.	2000 mA
t ≤ 10 μs; D = 0.005 ; T _J = 25 °C			
Reverse voltage ²⁾	V _R		Not designed for
	i c		reverse operation
ESD withstand voltage	V_{ESD}		8 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)			



Characteristics

I_F = 350 mA; T_J = 25 °C

Parameter	Symbol		Values
Peak Wavelength	λ_{peak}	typ.	730 nm
Centroid Wavelength ³⁾	$\lambda_{centroid}$	min.	710 nm
I _F = 350 mA	centiola	typ.	727 nm
		max.	740 nm
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	30 nm
Viewing angle at 50% I_v	2φ	typ.	120 °
Forward Voltage 4)	V _F	min.	1.80 V
l _F = 350 mA	•	typ.	1.95 V
		max.	2.20 V
Reverse current ²⁾	I _R		Not designed for reverse operation
Electrical thermal resistance junction/solderpoint with efficiency $\eta_{\rm e}$ = 64.5 %	$R_{thJSelec.}$	typ.	2.0 K / W



Brightness Groups

Group	Total radiant flux ¹⁾ I _F = 350 mA	Total radiant flux ¹⁾ I _F = 350 mA	PPF *	PPF *	PPF/W *	PF **	PF **	PF/W **
	min.	max.	min.	max.	typ.	min.	max.	typ.
	Φ _E	Φ _E	Φ _p	Φ _p		$\Phi_{\mathrm{p,b}}$	$\Phi_{\mathrm{p,b}}$	
TN	380 mW	415 mW	0.098 µmol/s	0.107 µmol/s	0.15 µmol/J	2.32 µmol/s	2.54 µmol/s	3.56 µmol/J
то	415 mW	450 mW	0.107 µmol/s	0.116 µmol/s	0.16 µmol/J	2.54 µmol/s	2.75 µmol/s	3.88 µmol/J
UJ	450 mW	485 mW	0.116 µmol/s	0.125 µmol/s	0.18 µmol/J	2.75 µmol/s	2.97 µmol/s	4.19 µmol/J
UK	485 mW	525 mW	0.125 µmol/s	0.135 µmol/s	0.19 µmol/J	2.97 µmol/s	3.21 µmol/s	4.53 µmol/J
UL	525 mW	565 mW	0.135 µmol/s	0.145 µmol/s	0.21 µmol/J	3.21 µmol/s	3.46 µmol/s	4.89 µmol/J

Note: [*] Photosynthetic Photon Flux includes wavelengths between 400 and 700 nm Note: [**] Photon Flux includes wavelengths between 280 and 800 nm Note: PPF and PF values are for reference only

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ I _F = 350 mA min. V _F	Forward Voltage ⁴⁾ I _F = 350 mA max. V _F	
E1	1.80 V	1.90 V	
E2	1.90 V	2.00 V	
F1	2.00 V	2.10 V	
F2	2.10 V	2.20 V	

Centroid Wavelength

Group	Centroid Wavelength ³⁾ I _F = 350 mA	Centroid Wavelength ³⁾ I _F = 350 mA	
	min.	max.	
	$\lambda_{ ext{centroid}}$	$\lambda_{centroid}$	
1	710 nm	740 nm	



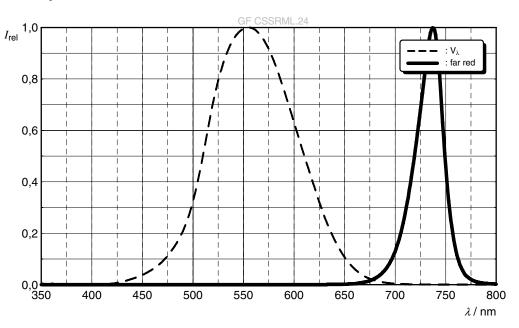
Group Name on Label

Example: TN-1-E1 Brightness	Wavelength	Forward Voltage
TN	1	E1



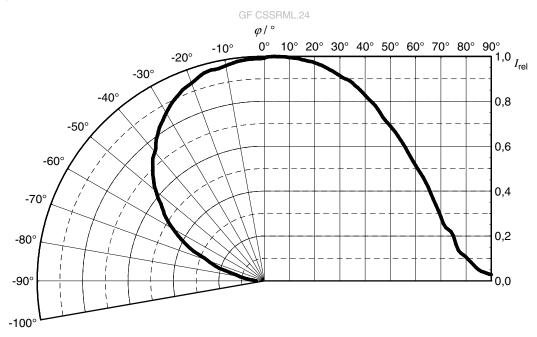
Relative Spectral Emission ⁵⁾

 $I_{rel} = f(\lambda); I_{F} = 350 \text{ mA}; T_{J} = 25 \text{ }^{\circ}\text{C}$



Radiation Characteristics ⁵⁾

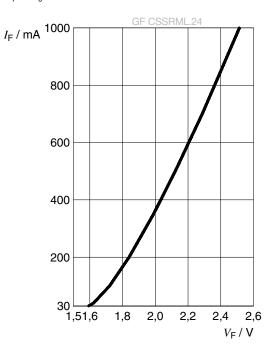
 $I_{rel} = f(\phi); T_J = 25 \ ^{\circ}C$





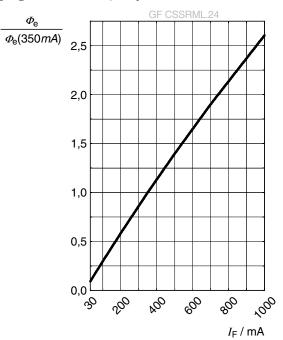
Forward current ⁵⁾

 $I_F = f(V_F); T_J = 25 \ ^{\circ}C$



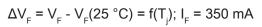
Relative Radiant Power 5), 6)

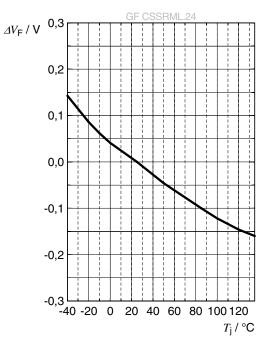
 $\Phi_{\rm E}/\Phi_{\rm E}(350 \text{ mA}) = f(I_{\rm F}); T_{\rm J} = 25 \text{ °C}$





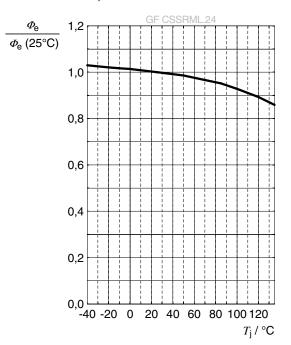
Forward Voltage ⁵⁾





Relative Radiant Power ⁵⁾

 $\Phi_{_{\rm E}}/\Phi_{_{\rm E}}(25 \ ^{\circ}{\rm C}) = f(T_{_{\rm i}}); I_{_{\rm F}} = 350 \text{ mA}$

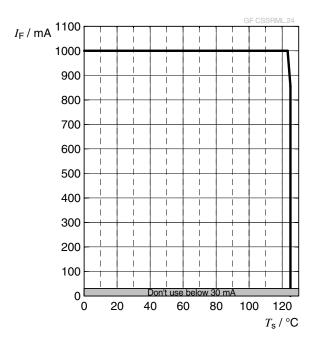


Centroid Wavelength ⁵⁾



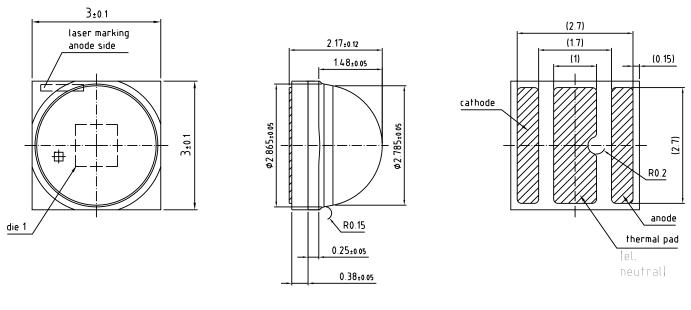
Max. Permissible Forward Current

 $I_F = f(T)$





Dimensional Drawing 7)



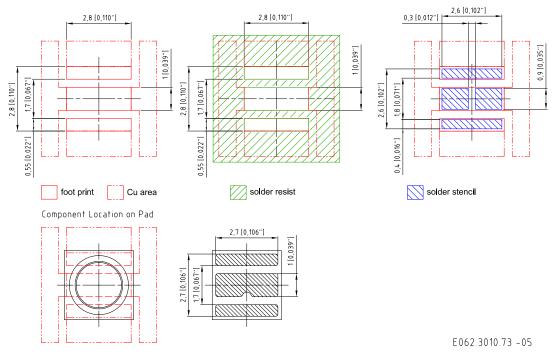
C69062-A0014-A2-01

Further Information:

Approximate Weight:	27.7 mg
Package marking:	Anode
ESD advice:	The device is protected by ESD device which is connected in parallel to the Chip.



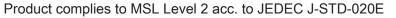
Recommended Solder Pad 7)

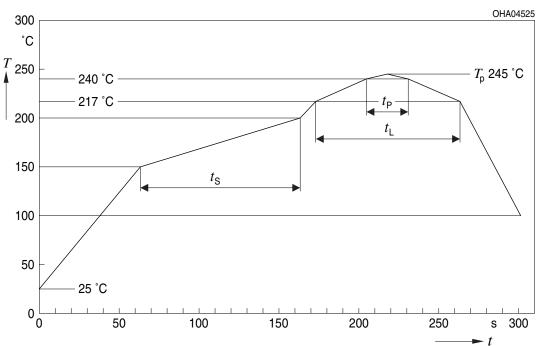


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Further information can be found in our Application Note: "Handling and Processing Details for Ceramic LEDs".



Reflow Soldering Profile





Profile Feature	Symbol	Pb	Pb-Free (SnAgCu) Assembly		
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat [•]) 25 °C to 150 °C			2	3	K/s
Time t _s T _{Smin} to T _{Smax}	t _s	60	100	120	S
Ramp-up rate to peak ^{*)} T_{smax} to T_{P}			2	3	K/s
Liquidus temperature	TL		217		°C
Time above liquidus temperature	t		80	100	S
Peak temperature	T _P		245	260	°C
Time within 5 °C of the specified peak temperature T_{p} - 5 K	t _P	10	20	30	S
Ramp-down rate* T _P to 100 °C			3	6	K/s
Time 25 °C to T _P				480	S

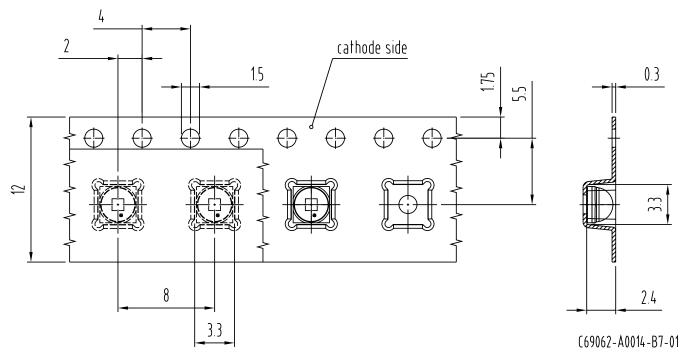
All temperatures refer to the center of the package, measured on the top of the component

 * slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

GF CSSRML.24 DATASHEET

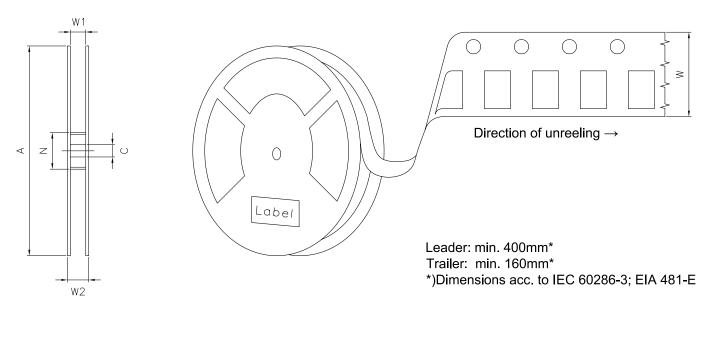


Taping 7)





Tape and Reel⁸⁾

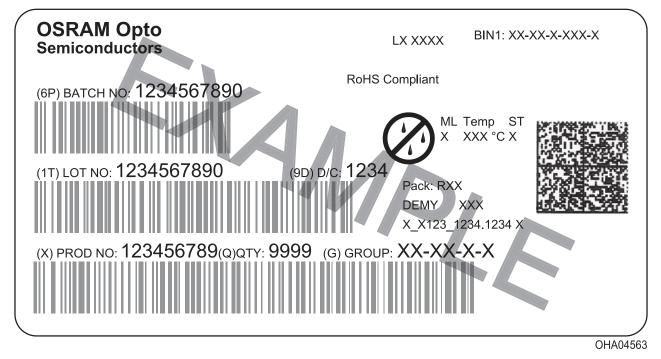


Reel Dimensions

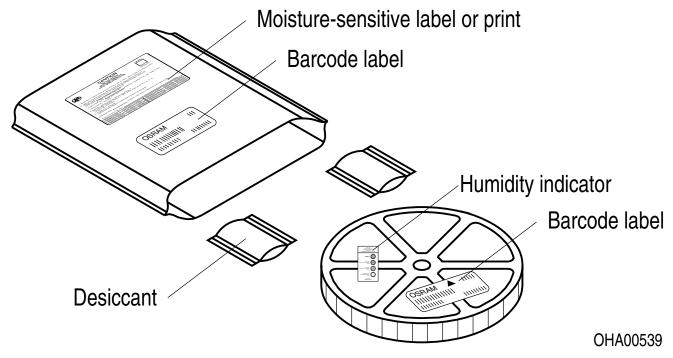
А	W	N _{min}	W ₁	$W_{2\text{max}}$	Pieces per PU
330 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	3000



Barcode-Product-Label (BPL)



Dry Packing Process and Materials



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

This device is designed for specific/recommended applications only. Please consult OSRAM Opto Semiconductors Sales Staff in advance for detailed information on other non-recommended applications (e.g. automotive).

Change management for this component is aligned with the requirements of the lighting market.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



Glossary

- ¹⁾ **Brightness:** Brightness values are measured during a current pulse of typically 10 ms, with a tolerance of +/- 7%.
- ²⁾ **Reverse Operation:** Not designed for reverse operation. Continuous reverse operation can cause migration and damage of the device.
- ³⁾ Wavelength: The wavelength is measured at a current pulse of typically 10 ms, with a tolerance of ± 0.5 nm.
- ⁴⁾ **Forward Voltage:** The Forward voltage is measured during a current pulse duration of typically 1 ms with a tolerance of ± 0.05V.
- ⁵⁾ **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁶⁾ **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- ⁷⁾ **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ⁸⁾ **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision History

Version	Date	Change
1.0	2022-04-27	Initial Version



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

Published by ams-OSRAM AG Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved

